BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS017017012-SF-5K

Description: 17.00 x 17.00 x 12.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin
Heat Sink Attachment: superGRIP
Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Features a low profile, slant fin array that offers many of the performance benefits of maxiFLOW™ at a great value
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- · Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	12.65 °C/W	9.6 °C/W	8.2 °C/W	7.3 °C/W	6.7 °C/W	6.2 °C/W	5.8 °C/W
	Ducted Flow	7.5	6.4	5.7	5.2	4.8	4.5	4.2

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
	17.00 mm	17.00 mm	12.00 mm	17 mm	N/A	BLACK-ANODIZED
*Image above is for illustration purpose only.	Dimension Dimension Thermal papplication ATS reserved performar ATS certification	n D is fin tip to fin tip performance data are n. rves the right to updance.	e provided for reference or change its prokens k assembly is RoHS	m of the base to the nce only. Actual perioducts without notice 6-6 and REACH comble.	ormanc to impr	e may vary by



